

February 1996

DS55113/DS75113 Dual TRI-STATE® Differential Line Driver

General Description

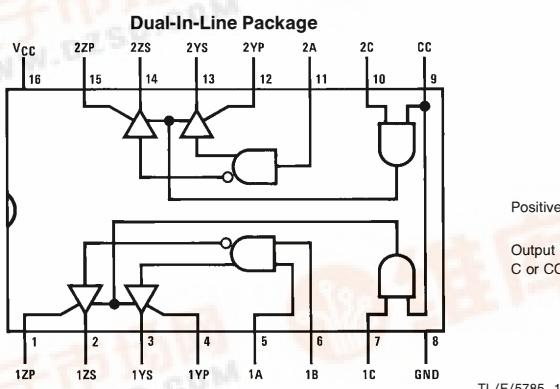
The DS55113/DS75113 dual differential line drivers with TRI-STATE outputs are designed to provide all the features of the DS55114/DS75114 line drivers with the added feature of driver output controls. There are individual controls for each output pair, as well as a common control for both output pairs. When an output control is low, the associated output is in a high-impedance state and the output can neither drive nor load the bus. This permits many devices to be connected together on the same transmission line for party-line applications.

The output stages are similar to TTL totem-pole outputs, but with the sink outputs, YS and ZS, and the corresponding active pull-up terminals, YP and ZP, available on adjacent package pins.

Features

- Each circuit offers a choice of open-collector or active pull-up (totem-pole) outputs
- Single 5V supply
- Differential line operation
- Dual channels
- TTL/LS compatibility
- High-impedance output state for party-line applications
- Short-circuit protection
- High current outputs
- Single-ended or differential AND/NAND outputs
- Common and individual output controls
- Clamp diodes at inputs
- Easily adaptable to DS55114/DS75114 applications

Connection Diagram



Top View
Order Number DS55113J, DS75113M or DS75113N
See NS Package Number J16A, M16A or N16A

For Complete Military 883 Specifications, see RETS Datasheet.

Order Number DS55113J/883

See NS Package Number J16A

Truth Table

Inputs				Outputs	
Output Control		Data		AND	NAND
C	CC	A	B*	Y	Z
L	X	X	X	Z	Z
X	L	X	X	Z	Z
H	H	L	X	L	H*
H	H	X	L	L	H
H	H	H	H	H	L

H = high level
L = low level
X = irrelevant
Z = high impedance (OFF)
*B input and 4th line of truth table applicable only to driver number 1

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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC}) (Note 1)	7V	Storage Temperature Range	–65°C to +150°C	
Input Voltage	5.5V	Lead Temperature (1/16" from case for 60 seconds): J Package	300 °C	
OFF-State Voltage Applied to Open-Collector Outputs	12V	Lead Temperature (1/16" from case for 4 seconds): N Package	260°C	
Maximum Power Dissipation* at 25°C				
Cavity Package	1433 mW	Supply Voltage (V_{CC})	Min	Max
Molded DIP Package	1362 mW	DS55113	4.5	5.5
SO Package	1002 mW	DS75113	4.75	5.25
Operating Free-Air Temperature Range		High Level Output Current (I_{OH})	–40	mA
DS55113	–55°C to +125°C	Low Level Output Current (I_{OL})	40	mA
DS75113	0°C to +70°C	Operating Free-Air Temperature (T_A)		
*Derate cavity package 9.6 mW/°C above 25°C; derate molded DIP package 10.9 mW/°C above 25°C; derate SO package 8.01 mW/°C above 25°C (Note 2).		DS55113	–55	125 °C
		DS75113	0	70 °C

Electrical Characteristics

Over recommended operating free-air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions (Note 3)	DS55113			DS75113			Units
			Min	Typ (Note 4)	Max	Min	Typ (Note 4)	Max	
V_{IH}	High Level Input Voltage		2			2			V
V_{IL}	Low Level Input Voltage				0.8			0.8	V
V_{IK}	Input Clamp Voltage	$V_{CC} = \text{Min}$, $I_I = -12 \text{ mA}$		–0.9	–1.5		–0.9	–1.5	V
V_{OH}	High Level Output Voltage	$V_{CC} = \text{Min}$, $V_{IH} = 2\text{V}$, $V_{IL} = 0.8\text{V}$	$I_{OH} = -10 \text{ mA}$	2.4	3.4		2.4	3.4	V
			$I_{OH} = -40 \text{ mA}$	2	3.0		2	3.0	
V_{OL}	Low Level Output Voltage	$V_{CC} = \text{Min}$, $V_{IH} = 2\text{V}$, $V_{IL} = 0.8\text{V}$, $I_{OL} = 40 \text{ mA}$		0.23	0.4		0.23	0.4	V
V_{OK}	Output Clamp Voltage	$V_{CC} = \text{Max}$, $I_O = -40 \text{ mA}$		–1.1	–1.5		–1.1	–1.5	V
$I_{O(\text{off})}$	Off-State Open-Collector Output Current	$V_{CC} = \text{Max}$	$V_{OH} = 12\text{V}$	$T_A = 25^\circ\text{C}$	1	10			
				$T_A = 125^\circ\text{C}$		200			
			$V_{OH} = 5.25\text{V}$	$T_A = 25^\circ\text{C}$			1	10	
				$T_A = 70^\circ\text{C}$				20	
I_{OZ}	Off-State (High-Impedance-State) Output Current	$V_{CC} = \text{Max}$, Output Controls at 0.8V	$T_A = 25^\circ\text{C}$, $V_O = 0 \text{ to } V_{CC}$		±10			±10	
			$T_A = \text{Max}$	$V_O = 0\text{V}$		–150		–20	
				$V_O = 0.4\text{V}$		±80		±20	
				$V_O = 2.4\text{V}$		±80		±20	
				$V_O = V_{CC}$		80		20	
I_I	Input Current at A, B, C	$V_{CC} = \text{Max}$, $V_I = 5.5\text{V}$			1		1		
	Maximum Input Voltage	CC			2			2	
I_{IH}	High Level Input Current	A, B, C	$V_{CC} = \text{Max}$, $V_I = 2.4\text{V}$			40		40	
	CC					80		80	
I_{IL}	Low Level Input Current	A, B, C	$V_{CC} = \text{Max}$, $V_I = 0.4\text{V}$			–1.6		–1.6	
	CC					–3.2		–3.2	

Electrical Characteristics

Over recommended operating free-air temperature range (unless otherwise noted) (Continued)

Symbol	Parameter	Conditions (Note 3)	DS55113			DS75113			Units
			Min	Typ (Note 4)	Max	Min	Typ (Note 4)	Max	
I _{OS}	Short-Circuit Output Current (Note 5)	V _{CC} = Max, V _O = 0V	-40	-90	-120	-40	-90	-120	mA
I _{CC}	Supply Current (Both Drivers)	All Inputs at 0V, No Load	V _{CC} = Max	47	65		47	65	mA
		T _A = 25°C	V _{CC} = 7V	65	85		65	85	

Note 1: All voltage values are with respect to network ground terminal.

Note 2: For operation above 25°C free-air temperature, refer to Dissipation Derating Curves in the Thermal information section.

Note 3: All parameters with the exception of OFF-state open-collector output current are measured with the active pull-up connected to the sink output.

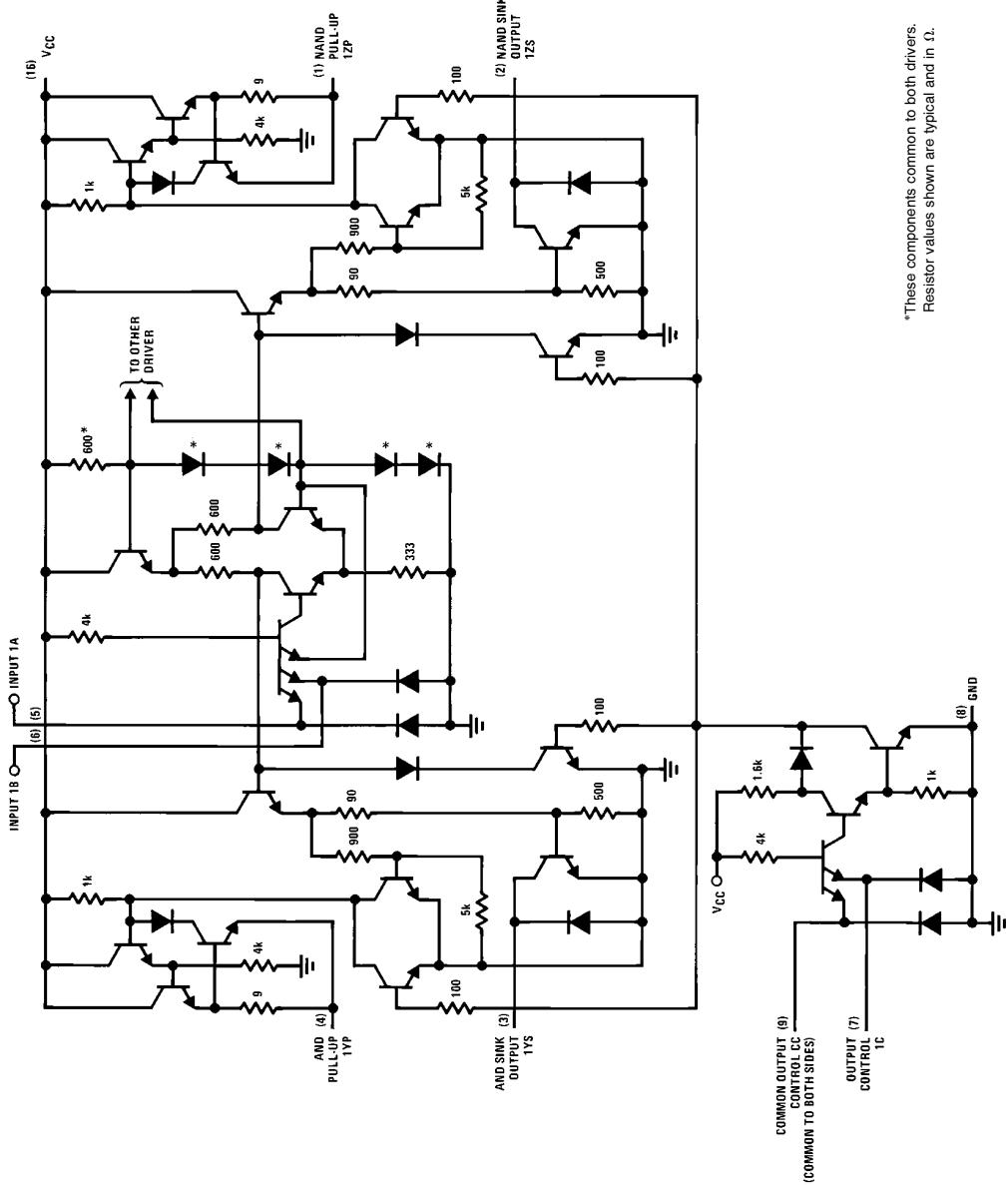
Note 4: All typical values are at T_A = 25°C and V_{CC} = 5V, with the exception of I_{CC} at 7V.

Note 5: Only one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

Switching Characteristics V_{CC} = 5V, C_L = 30 pF, T_A = 25°C

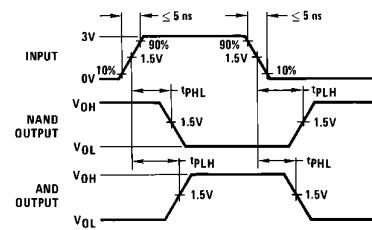
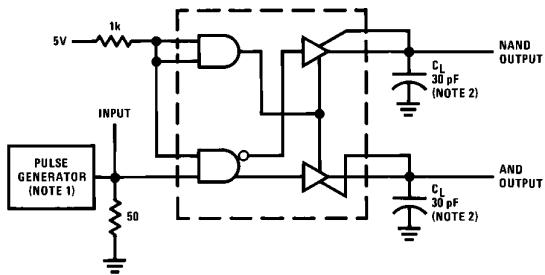
Symbol	Parameter	Conditions	DS55113			DS75113			Unit
			Min	Typ	Max	Min	Typ	Max	
t _{PLH}	Propagation Delay Time, Low-to High-Level Output	(Figure 1)		13	20		13	30	ns
t _{PHL}	Propagation Delay Time, High-to Low-Level Output			12	20		12	30	ns
t _{PZH}	Output Enable Time to High Level	R _L = 180Ω, (Figure 2)		7	15		7	20	ns
t _{PZL}	Output Enable Time to Low Level	R _L = 250Ω, (Figure 3)		14	30		14	40	ns
t _{PHZ}	Output Disable Time from High Level	R _L = 180Ω, (Figure 2)		10	20		10	30	ns
t _{PLZ}	Output Disable Time from Low Level	R _L = 250Ω, (Figure 3)		17	35		17	35	ns

Schematic Diagram (One side shown only)



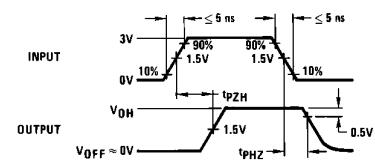
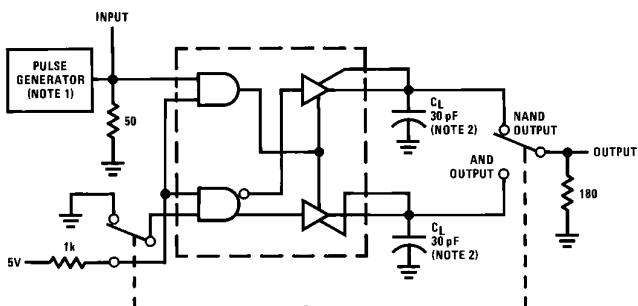
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AC Test Circuits and Switching Time Waveforms



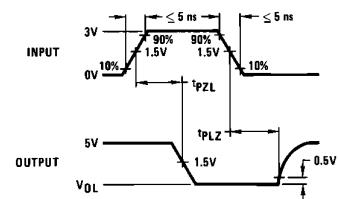
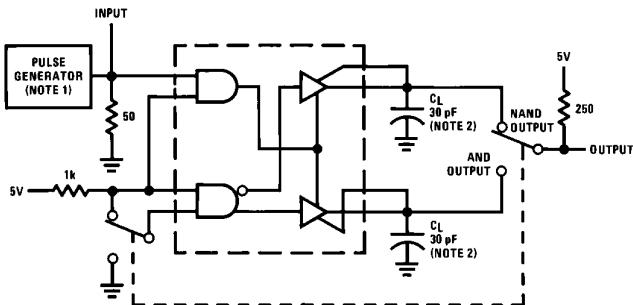
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FIGURE 1. t_{PLH} and t_{PHL}



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FIGURE 2. t_{PZH} and t_{PHZ}



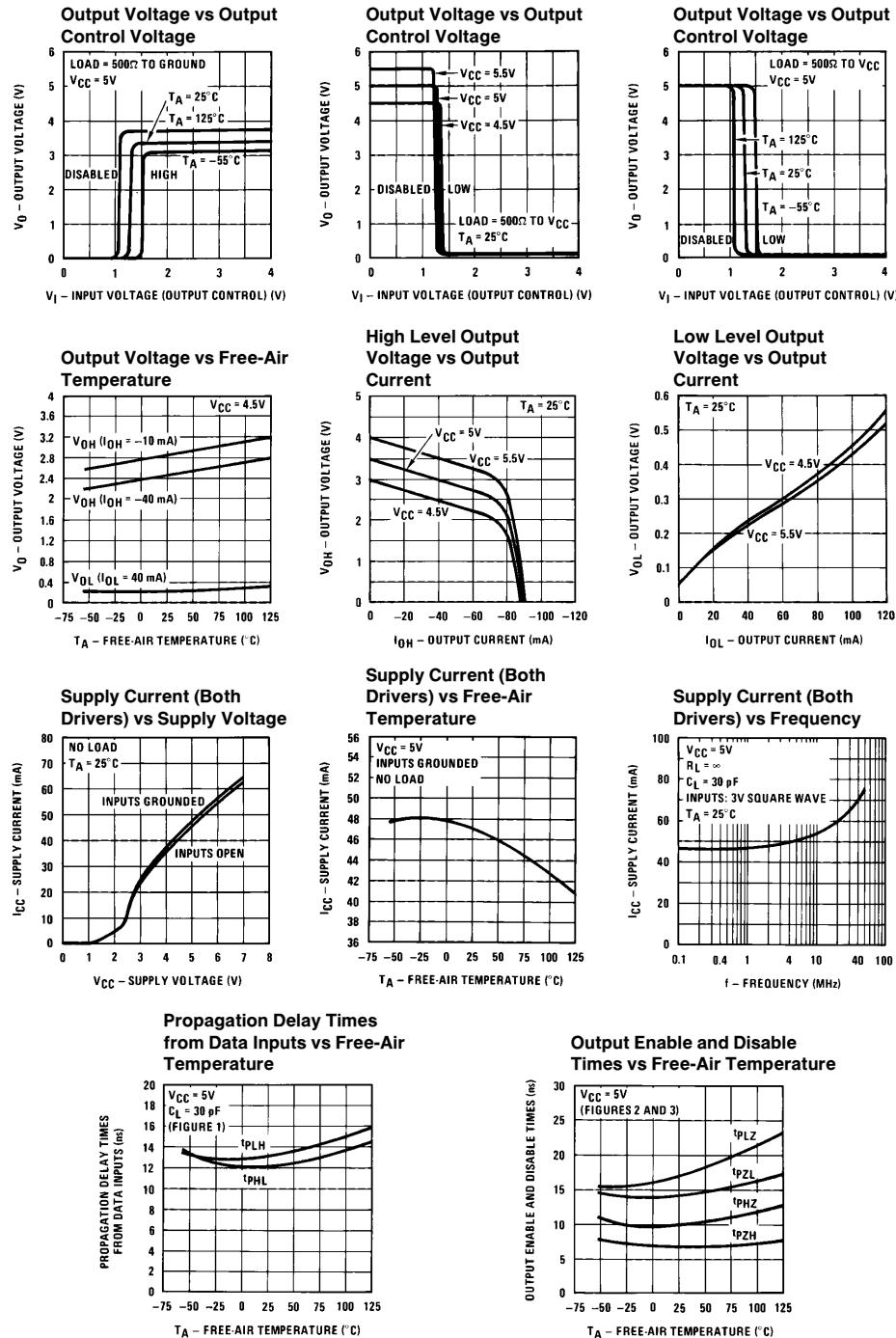
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FIGURE 3. t_{PZL} and t_{PLZ}

Note 1: The pulse generator has the following characteristics: $Z_{OUT} = 50\Omega$, PRR = 500 kHz, $t_W = 100$ ns.

Note 2: C_L includes probe and jig capacitance.

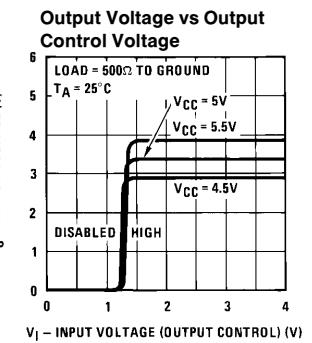
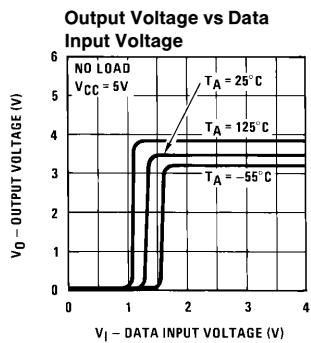
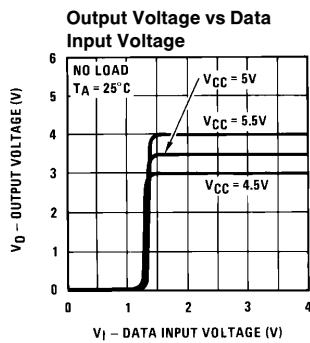
Typical Performance Characteristics*



*Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75V and above 5.25V are applicable to DS55113 circuits only. These parameters were measured with the active pull-up connected to the sink output.

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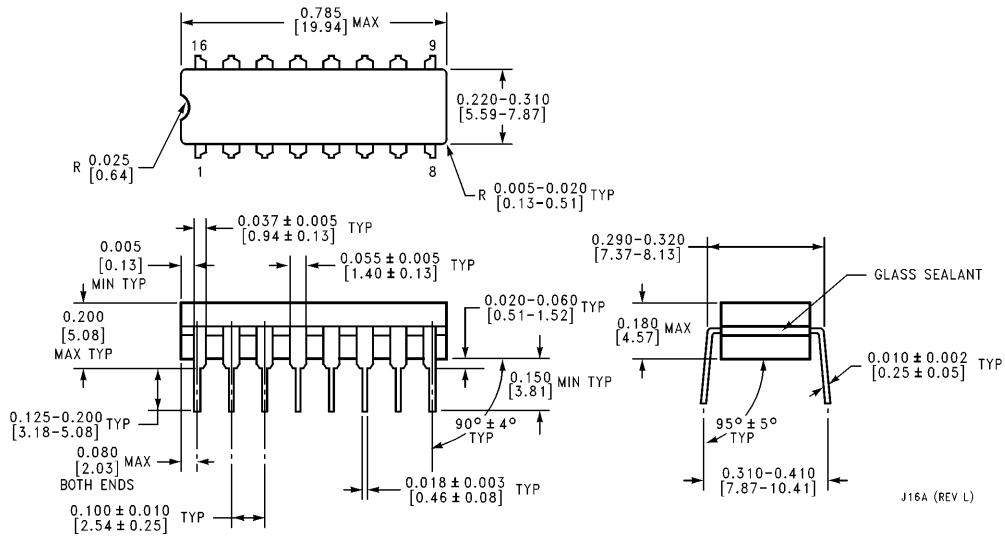
Typical Performance Characteristics* (Continued)



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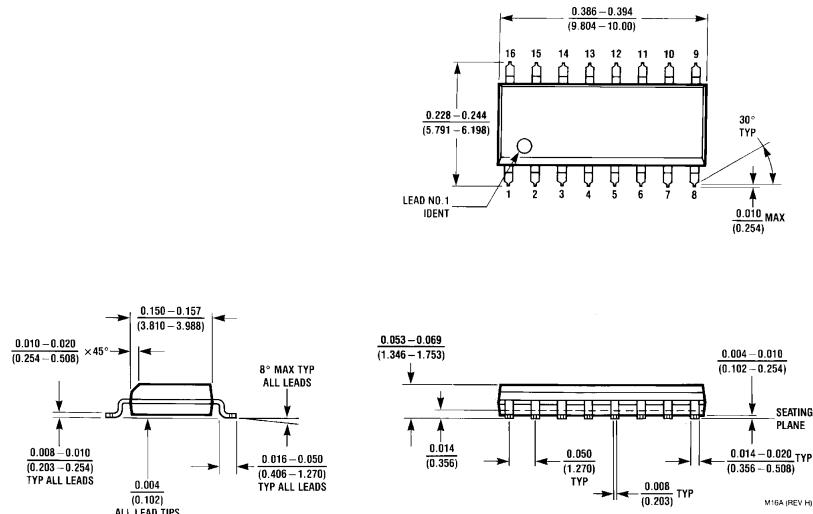
*Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75V and above 5.25V are applicable to DS55113 circuits only. These parameters were measured with the active pull-up connected to the sink output.

Physical Dimensions inches (millimeters)



Ceramic Dual-In-Line Package (J)
Order Number DS55113J
NS Package Number J16A

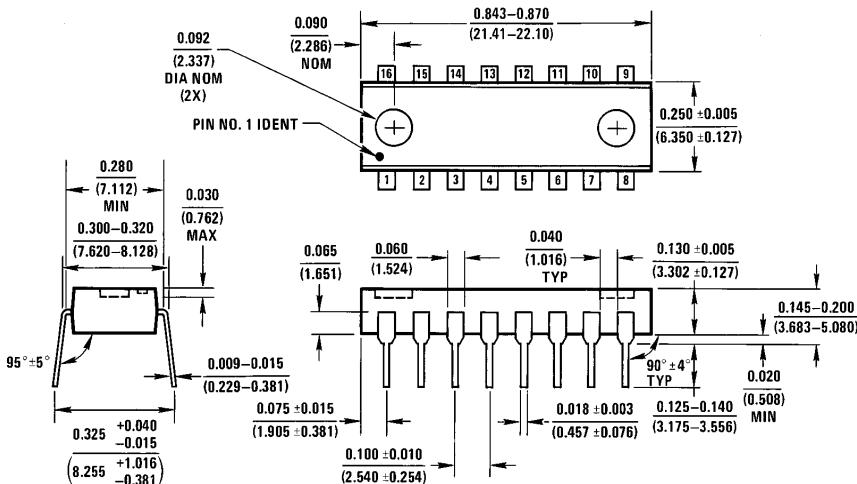
Physical Dimensions inches (millimeters) (Continued)



SO Package (M)
Order Number DS75113M
NS Package Number M16A

DS55113/DS75113 Dual TRI-STATE Differential Line Driver

Physical Dimensions inches (millimeters) (Continued)



N16A (REV E)

Molded Dual-In-Line Package (N)
Order Number DS75113N
NS Package Number N16A

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